## SPECIFICATION FOR APPROVAL

# 承 认 书

CUSTOMER					NUMBER			
客户名	讼:				编	号:		
	DESCR	RIPTIO	N			QUAN	NTITY	
	品	名:	贴片共模滤波器			数	量:	
	PART	NO.				DATE	3	
	型	号:	BCCM1008-2-5017	T02		日	期:	
	CUSTO	MER P	ART NO.			NOTE	Ē	
	客户制	<b>斗号:</b>				注	解:	
					SIGNATURE 承认签章			
			APPROVED BY 核 准	Q. C. DEPT. 品 管	CHECKED BY 核 查		DRAWN BY 制作	
		1			1	- 1		1

## 深圳市惠尔德电子有限公司

SHENZHEN HUIERDE ELECTRONICS CO., LTD.

地址: 深圳市龙华区观澜街道福民福苑工业区二栋三楼

Tel: 13510325766

#### DC COMMON MODE FILTER

#### **FEATURES**

- A chip-type common mode filter for large current applications. Common mode impedance surpasses  $500\,\Omega$  at 100MHz. Noise is greatly suppressed.
- Capable of handling the highest current (up to 6.5A) of any chiptype common mode filter.
- 'Height and size have been considered , resulting in a compact and light-weight choke coil. Applicable for the miniaturization required to reduce the size and weight of portable equipment.
- 'The products contain no lead and also support lead-free soldering.
- 'The product does not contain regulatde substances that are slated to be included in ROHS.



#### **APPLICATIONS**

Used for power line noise suppression for any electonic-devices Used to counter adapter/battery line noise for relatively large electronic devices such as notebook PCs, stand-alone word processors, etc

#### TEMPERATURE RANGES

Operating	<b>-</b> 40to+125℃	
Storage (After mount)	<b>-</b> 40to+125℃	

#### Part Number System

<b>BCCM</b>	1008	<u>-2</u>	<u>-501</u>	<u>T</u>	02
(1)	(2)	(3)	<b>(</b> 4 <b>)</b>	(5)	<b>(6)</b>

- ① Type:BCCM
- ② External Dimensions (L×W) (mm):10.0\*8.0
- ③ Number of Lines: 2
- 4 Impedance:  $501=500 \Omega$
- 5 Packing: Tape & Reel
- 6 Management Symbol:02

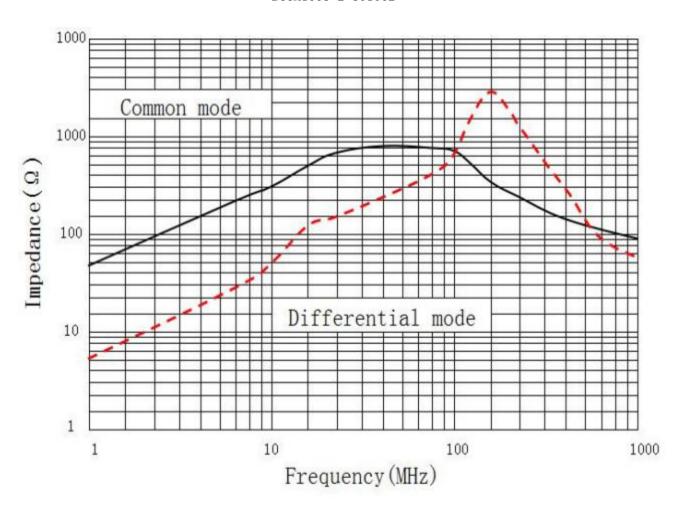
#### **ELECTRICAL CHARACTERISTICS**

Part No.	lmpedance (Ω)min[at 100MHz]			lnsulation resistance (MΩ)min
BCCM1008-2-501T02	500	12	6.5	10

### DC COMMON MODE FILTER

## TYPICAL ELECTRICAL CHARACTERISTICS IMPEDANCE vs. FREQUENCY CHARACTERISTICS

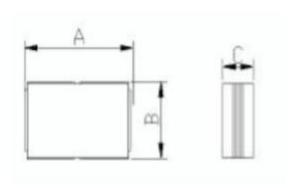
BCCM1008-2-501T02

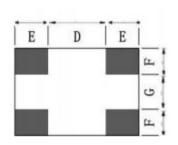


### DC COMMON MODE FILTER

## SHAPES AND DIMENSIONS/CIRCUIT DIAGRAM/RECOMMENDED PC BOARD PATTERN (REFLOW SOLDERING)

◆ Dimensions (mm)





UNIT: mm

 $A:10.2 \pm 0.5$ 

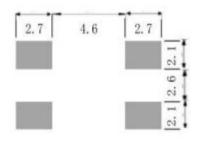
 $B:8.2\pm 0.5$ 

C:6.0 (MAX)

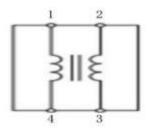
D:5.0 E:2.50

F:1.90 G:3.0

◆ Land Pattern(mm)



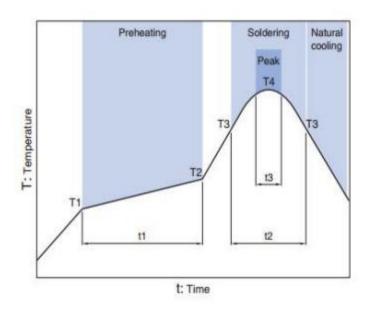
◆Schematics(Bottom)



No polarity

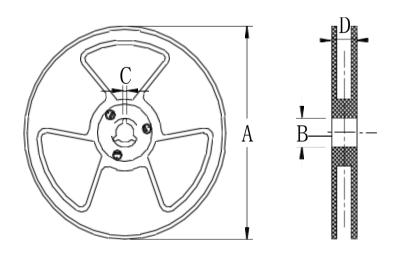
## DC COMMON MODE FILTER

#### **Recommended Reflow Temperature Curve**



Preheating			Solderin	Soldering		Peak	
Temp.		Time	Temp.	Time	Temp.	Time	
T1	T2	tt	Т3	t2	T4	t3	
150°C	180°C	60 to 120s	230°C	10 to 30s	245°C	5s	

## Package size (mm)



Specs size	13"	7"
A	Ф 330±2.0	Φ178±2.0
В	Φ90	± 2 0
С	2 3	
D	21.5	